74HC7014

Hex non-inverting precision Schmitt-trigger Rev. 4 — 26 November 2015

Product data sheet

1. **General description**

The 74HC7014 is a hex buffer with precision Schmitt-trigger inputs. The precisely defined trigger levels are lying in a window between $0.55 \times V_{CC}$ and $0.65 \times V_{CC}$. It makes the circuit suitable to operate in a highly noisy environment. Input shorts are allowed to -1.5 V and +16 V without disturbing other channels. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}. Schmitt trigger inputs transform slowly changing input signals into sharply defined jitter-free output signals.

Features and benefits 2.

- Operating voltage 3.0 V to 6.0 V
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

Applications 3.

Wave and pulse shapers for highly noisy environments

Ordering information

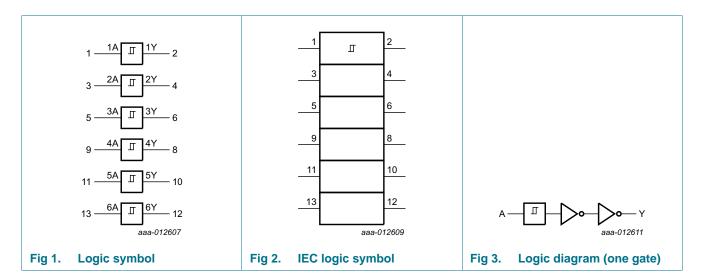
Table 1. **Ordering information**

Type number	Package			
	Temperature range	Name	Description	Version
74HC7014D	−40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1



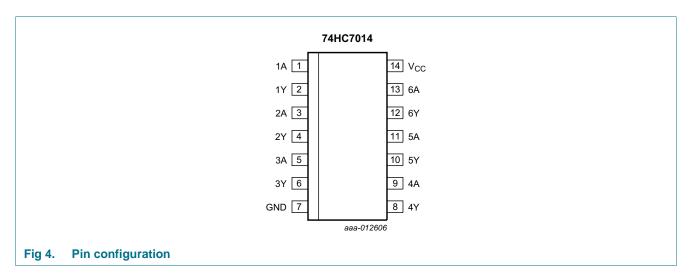
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5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 6A	1, 3, 5, 9, 11, 13	data input
1Y to 6Y	2, 4, 6, 8, 10, 12	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

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7. Functional description

Table 3. Functional table[1]

Input	Output
nA	nY
L	L
Н	Н

^[1] H = HIGH voltage level; L = LOW voltage level

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	<u>[1]</u>	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	<u>[1]</u>	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO14 package	[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C

^[2] For SO14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

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10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C		–40 °C 35 °C	T _{amb} = -40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{OH}	HIGH-level	$V_I = V_{T+}$ or V_{T-}								
	output voltage	$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V_{OL}	LOW-level	$V_I = V_{T+}$ or V_{T-}			'					
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_{CC} = 6.00 \text{ V};$ $V_I = V_{CC} \text{ or GND}$	-	-	0.1	1.0	-	1.0	-	μА
		V _{CC} = 3.00 V to 6.00 V; V _I = 16 V or GND	-	-	0.5	5.0	-	5.0	-	μА
I _{CC}	DC supply	V _{CC} = 3.00 V	-	0.7	1.4	-	1.8	-	2.1	mA
	current	V _{CC} = 5.25 V	-	3.0	6.0	-	7.5	-	7.5	mA
		V _{CC} = 6.00 V	-	3.7	7.4	-	10.0	-	13.0	mA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

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11. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; for test circuit, see Figure 6.

Symbol Parameter		Conditions	Т	_{amb} = 25	°C	$T_{amb} = -40$	°C to +125 °C	Unit
			Min	Тур	Max	Max (85 °C)	Max (125 °C)	
t _{PHL}	HIGH to LOW	nA to nY; see Figure 5		•				
	propagation delay	V _{CC} = 3.00 V	-	95	475		715	ns
		V _{CC} = 4.75 V	-	38	115	-	175	ns
		V _{CC} = 6.00 V	-	27	73	93	112	ns
t _{PLH}	LOW to HIGH	nA to nY; see Figure 5						
	propagation delay	V _{CC} = 3.00 V	-	47	175	220	260	ns
		V _{CC} = 4.75 V	-	23	52	65	78	ns
		V _{CC} = 6.00 V	-	18	46	58	70	ns
t _t	transition time	see Figure 5	1					
		V _{CC} = 3.00 V	-	12	20	25	30	ns
		V _{CC} = 4.75 V	-	7	15	19	22	ns
		V _{CC} = 6.00 V	-	6	13	16	19	ns
C_{PD}	power dissipation capacitance	per gate; V _I = GND to V _{CC}	-	9	-	-	-	pF

^[1] t_t is the same as t_{THL} and t_{TLH} .

[2] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

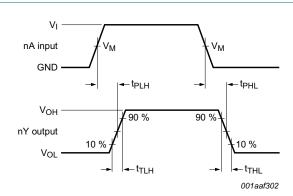
 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

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12. Waveforms



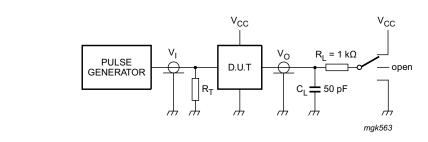
Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 5. The input (nA) to output (nY) propagation delays and output transition times

Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC7014	0.5V _{CC}	0.5V _{CC}



Test data is given in Table 9.

Definitions test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 $R_{T} = \mbox{Termination}$ resistance should be equal to output impedance Z_{o} of the pulse generator.

Fig 6. Test circuit for measuring switching times

Table 9. Test data

Туре	Input	Test	
	VI	t _r , t _f	t _{PHL} , t _{PLH}
74HC7014	GND to V _{CC}	6 ns	open

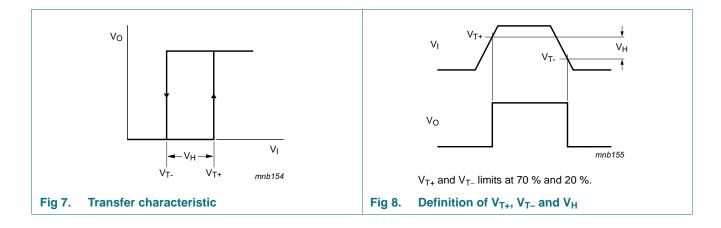
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13. Transfer characteristics

Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see Figure 7 and Figure 8.

Symbol	Parameter	Conditions	Та	T _{amb} = 25 °C		T _{amb} = 25 °C			–40 °C 35 °C		–40 °C 25 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max			
V_{T+}	positive-going	V _{CC} = 3.00 V	-	1.86	1.95	-	1.95	-	1.95	V		
	threshold voltage	V _{CC} = 4.75 V	-	2.94	3.08	-	3.08	-	3.08	V		
		V _{CC} = 5.00 V	-	3.10	3.25	-	3.25	-	3.25	V		
		V _{CC} = 5.25 V	-	3.25	3.41	-	3.41	-	3.41	V		
		V _{CC} = 6.00 V	-	3.72	3.90	-	3.90	-	3.90	V		
V_{T-}	negative-going	V _{CC} = 3.00 V	1.65	1.74	-	1.65	-	1.65	-	V		
	threshold voltage	V _{CC} = 4.75 V	2.62	2.76	-	2.62	-	2.62	-	V		
		V _{CC} = 5.00 V	2.75	2.90	-	2.75	-	2.75	-	V		
		V _{CC} = 5.25 V	2.89	3.05	-	2.89	-	2.89	-	V		
		V _{CC} = 6.00 V	3.30	3.48	-	3.30	-	3.30	-	V		
V_{H}	hysteresis	V _{CC} = 3.00 V	50	120	-	50	-	50	-	V		
	voltage	V _{CC} = 4.75 V	100	180	-	100	-	100	-	V		
		V _{CC} = 5.00 V	120	200	-	120	-	120	-	V		
		V _{CC} = 5.25 V	130	210	-	130	-	130	-	V		
		V _{CC} = 6.00 V	160	240	-	160	-	160	-	V		

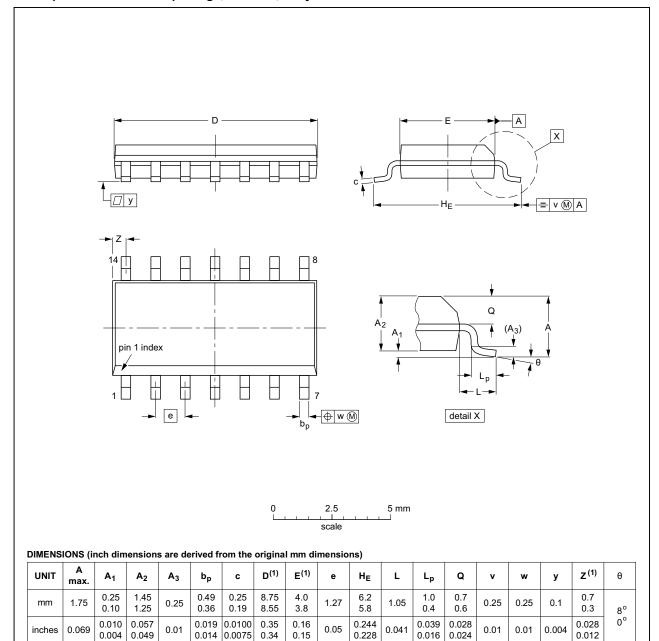


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14. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFERENCES				ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				99-12-27 03-02-19

Fig 9. Package outline SOT108-1 (SO14)

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15. Abbreviations

Table 11. Abbreviations

Acronym	Description
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

16. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC7014 v.4	20151126	Product data sheet	-	74HC7014 v.3	
Modifications:	Type number 74HC7014N (SOT27-1) removed.				
74HC7014 v.3	20140430	Product data sheet	-	74HC7014_CVN v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	Legal texts have been adapted to the new company name where appropriate.				
74HC7014_CVN v.2	19980708	Product specification	-	74HC7014 v.1	
74HC7014 v.1	19930901	Product specification	-	-	

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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